

# N-channel TrenchMOS intermediate level FET Rev. 2 — 1 October 2010

Product data sheet

#### 1. **Product profile**

#### 1.1 General description

Intermediate level gate drive N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using advanced TrenchMOS technology. This product has been designed and qualified to the appropriate AEC Q101 standard for use in high performance automotive applications.

#### 1.2 Features and benefits

- AEC Q101 compliant
- Suitable for standard and logic level gate drive sources

#### 1.3 Applications

- 12 V Automotive systems
- Electric and electro-hydraulic power steering
- Motors, lamps and solenoid control

#### 1.4 Quick reference data

#### Table 1 Quick reference data

- Suitable for thermally demanding environments due to 175 °C rating
- Start-Stop micro-hybrid applications
- Transmission control
- Ultra high performance power switching

Table 1.	QUICK reference	uata					
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
$V_{DS}$	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C		-	-	30	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; see <u>Figure 1</u>	<u>[1]</u>	-	-	50	A
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	-	80	W
Static cha	racteristics						
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 12 A; T <sub>j</sub> = 25 °C; see <u>Figure 11</u>		-	8.3	9.8	mΩ



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Quick reference da	tacontinued				
Parameter	Conditions	Min	Тур	Max	Unit
e ruggedness					
non-repetitive drain-source avalanche energy	$ \begin{split} I_D &= 50 \text{ A};  V_{sup} \leq 30  V; \\ R_{GS} &= 50  \Omega;  V_{GS} = 10  V; \\ T_{j(init)} &= 25 ^\circ\text{C};  \text{unclamped} \end{split} $	-	-	74	mJ
characteristics					
gate-drain charge	$I_D = 25 \text{ A}; V_{DS} = 24 \text{ V};$ $V_{GS} = 10 \text{ V}; \text{ see } \underline{Figure 13};$ $\text{see } \underline{Figure 14}$	-	7.9	-	nC
	Parameter e ruggedness non-repetitive drain-source avalanche energy characteristics	$\label{eq:constraints} \begin{array}{l} \text{non-repetitive} & I_D = 50 \text{ A}; \ V_{sup} \leq 30 \text{ V}; \\ \text{drain-source} & R_{GS} = 50 \ \Omega; \ V_{GS} = 10 \text{ V}; \\ \text{avalanche energy} & T_{j(\text{init})} = 25 \ ^\circ\text{C}; \ \text{unclamped} \end{array}$	ParameterConditionsMine ruggedness $I_D = 50 \text{ A}; V_{sup} \le 30 \text{ V};$ drain-source avalanche energy $I_D = 50 \text{ A}; V_{Sup} \le 30 \text{ V};$ $R_{GS} = 50 \Omega; V_{GS} = 10 \text{ V};$ $T_{j(init)} = 25 ^{\circ}\text{C};$ unclamped-characteristics $I_D = 25 \text{ A}; V_{DS} = 24 \text{ V};$ $V_{GS} = 10 \text{ V};$ see Figure 13;-	ParameterConditionsMinTypPruggedness $I_D = 50 \text{ A}; V_{sup} \le 30 \text{ V};$ drain-source avalanche energy $I_D = 50 \text{ A}; V_{sup} \le 30 \text{ V};$ $T_{g(s)} = 25  \Omega; V_{GS} = 10 \text{ V};$ $T_{j(init)} = 25 ^{\circ}\text{C};$ unclampedcharacteristicsgate-drain charge $I_D = 25 \text{ A}; V_{DS} = 24 \text{ V};$ $V_{GS} = 10 \text{ V};$ see Figure 13;-7.9	ParameterConditionsMinTypMaxPruggednessnon-repetitive drain-source avalanche energy $I_D = 50 \text{ A}; V_{sup} \le 30 \text{ V};$ $R_{GS} = 50 \Omega; V_{GS} = 10 \text{ V};$ $T_{j(init)} = 25 ^{\circ}\text{C}; unclamped74Characteristicsgate-drain chargeI_D = 25 \text{ A}; V_{DS} = 24 \text{ V};V_{GS} = 10 \text{ V}; see Figure 13;-7.9-$

[1] Continuous current is limited by package.

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### 2. Pinning information

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Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		2
2	D	drain	mb	
3	S	source		
mb	D	mounting base; connected to drain		mbb076 S
			SOT428 (DPAK)	

### 3. Ordering information

Table 3.	Ordering	information
	er aorrig	

Type number	Package		
	Name	Description	Version
BUK6209-30C	DPAK	plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)	SOT428

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#### 4. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C		-	30	V
V <sub>GS</sub>	gate-source voltage	Pulsed	<u>[1]</u>	-20	20	V
		DC	[2]	-16	16	V
I <sub>D</sub>	drain current	$T_{mb}$ = 25 °C; $V_{GS}$ = 10 V; see Figure 1	<u>[3]</u>	-	50	А
		$T_{mb}$ = 100 °C; $V_{GS}$ = 10 V; see Figure 1		-	46	А
I <sub>DM</sub>	peak drain current	$T_{mb} = 25 \text{ °C}; t_p \le 10 \mu\text{s}; \text{ pulsed};$ see Figure 3		-	262	A
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	80	W
T <sub>stg</sub>	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-drain	n diode					
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	[3]	-	50	А
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	262	А
Avalanche r	uggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$\label{eq:ID} \begin{array}{l} I_D = 50 \; A; \; V_sup \leq 30 \; V; \; R_GS = 50 \; \Omega; \\ V_GS = 10 \; V; \; T_{j(init)} = 25 \; ^\circC; \; unclamped \end{array}$		-	74	mJ
E <sub>DS(AL)R</sub>	repetitive drain-source avalanche energy		[4][5][6]	-	-	mJ

[1] Accumulated pulse duration not to exceed 5mins.

[2] -16V accumulated duration not to exceed 168hrs.

[3] Continuous current is limited by package.

[4] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

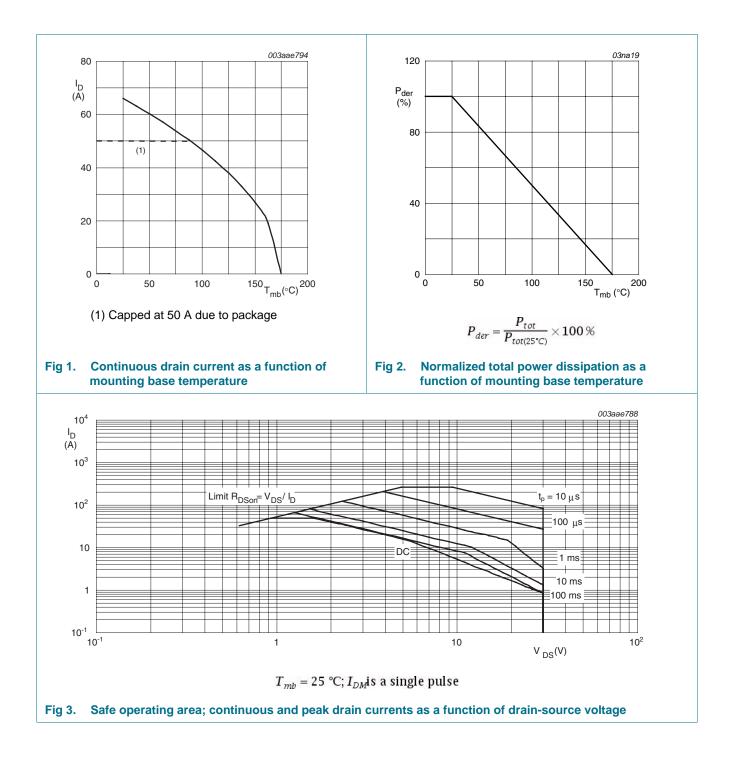
[5] Repetitive avalanche rating limited by an average junction temperature of 170 °C.

[6] Refer to application note AN10273 for further information.

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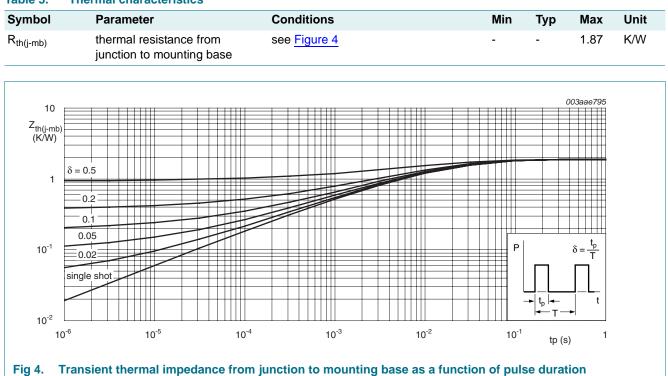
# BUK6209-30C

#### N-channel TrenchMOS intermediate level FET



N-channel TrenchMOS intermediate level FET

### 5. Thermal characteristics



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### 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics					
V <sub>(BR)DSS</sub>	drain-source	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	30	-	-	V
	breakdown voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^{\circ}C$	27	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 25 °C; see <u>Figure 9</u> ; see <u>Figure 10</u>	1.8	2.3	2.8	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = -55 °C; see <u>Figure 9</u>	-	-	3.3	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 175 °C; see <u>Figure 9</u>	0.8	-	-	V
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = 30 V; $V_{GS}$ = 0 V; $T_j$ = 175 °C	-	-	500	μA
		$V_{DS} = 30 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.02	1	μA
I <sub>GSS</sub>	gate leakage current	$V_{DS}$ = 0 V; $V_{GS}$ = 20 V; $T_j$ = 25 °C	-	2	100	nA
		$V_{DS}$ = 0 V; $V_{GS}$ = -20 V; $T_j$ = 25 °C	-	2	100	nA
R <sub>DSon</sub> drain-source or resistance	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 12 A; T <sub>j</sub> = 25 °C; see <u>Figure 11</u>	-	8.3	9.8	mΩ
		V <sub>GS</sub> = 5 V; I <sub>D</sub> = 12 A; T <sub>j</sub> = 25 °C; see <u>Figure 11</u>	-	12	15	mΩ
		V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 12 A; T <sub>j</sub> = 25 °C; see <u>Figure 11</u>	-	14.4	19.2	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 12 A; T <sub>j</sub> = 175 °C; see <u>Figure 12</u>	-	-	18.6	mΩ
Dynamic ch	aracteristics					
Q <sub>G(tot)</sub> total gate charge		$I_D$ = 25 A; $V_{DS}$ = 24 V; $V_{GS}$ = 10 V; see <u>Figure 13</u> ; see <u>Figure 14</u>	-	30.5	-	nC
		I <sub>D</sub> = 25 A; V <sub>DS</sub> = 24 V; V <sub>GS</sub> = 5 V; see <u>Figure 13</u> ; see <u>Figure 14</u>	-	17.4	-	nC
Q <sub>GS</sub>	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 24 \text{ V}; V_{GS} = 10 \text{ V};$	-	6.7	-	nC
Q <sub>GD</sub>	gate-drain charge	see Figure 13; see Figure 14	-	7.9	-	nC
C <sub>iss</sub>	input capacitance	$V_{GS} = 0 V; V_{DS} = 25 V; f = 1 MHz;$	-	1315	1760	pF
C <sub>oss</sub>	output capacitance	$T_j = 25 \text{ °C}; \text{ see } Figure 15$	-	249	300	pF
C <sub>rss</sub>	reverse transfer capacitance	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 30 V; f = 1 MHz; T <sub>j</sub> = 25 °C; see <u>Figure 15</u>	-	157	220	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 25 \text{ V}; \text{ R}_{L} = 1 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	9.2	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 10 \ \Omega$	-	23	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	45.5	-	ns
t <sub>f</sub>	fall time		-	31.3	-	ns
L <sub>D</sub>	internal drain inductance	from upper edge of drain mounting base to centre of die; $T_j = 25 \text{ °C}$	-	3.5	-	nH
L <sub>S</sub>	internal source inductance	from source lead to source bond pad; $T_i = 25 ^{\circ}\text{C}$	-	7.5	-	nH

Table 6.

Symbol

Characteristics ... continued

Conditions

Parameter

## BUK6209-30C

Max

Unit

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Тур

Min

urce-drain						
)	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; see <u>Figure 16</u>	-	0.8	1.2	V
	reverse recovery time	$I_{S} = 20 \text{ A}; dI_{S}/dt = -100 \text{ A}/\mu\text{s}; V_{GS} = 0 \text{ V};$	; -	34	-	ns
	recovered charge	V <sub>DS</sub> = 25 V	-	32	-	nC
		003aae784			003aae785	
60		200 ID			-	
g <sub>fs</sub> (S)		(A)	10.0	V <sub>GS</sub> (	(V) = 8.0	
40		150			6.0	
		100				
					4.5	
20		50			4.0	
0					3.2	
0	20 40	I <sub>D</sub> (A) <sup>60</sup> 0	1 2	3,	4 V <sub>DS</sub> (V)	
	$T_j = 25 ^{\circ}\text{C}; V_{DS} = 25$	5 V	$T_j = 25$ °C; $t_p =$	-		
	$T_j = 25 ^{\circ}\text{C}; V_{DS} = 25$ ward transconductance an current; typical values	5 V as a function of Fig 6. Output c	$T_j = 25$ °C; $t_p =$ characteristics: of drain-source	drain cu		
	vard transconductance	5 V as a function of Fig 6. Output c	characteristics:	drain cu e voltage		
60	vard transconductance	5 V as a function of <sup>003aae786</sup> <sup>25</sup> R <sub>DSon</sub>	characteristics:	drain cu e voltage	e; typica	
draiı	vard transconductance	5 V as a function of Fig 6. Output of function	characteristics:	drain cu e voltage	e; typica	
60 ID	vard transconductance	5 V as a function of Fig 6. Output of function	characteristics:	drain cu e voltage	e; typica	
60 I <sub>D</sub> (A)	vard transconductance	5 V as a function of Fig 6. Output of function 003aae786 Poson (mΩ) 20 20 20 20 20 20 20 20	characteristics:	drain cu e voltage	e; typica	
60 I <sub>D</sub> (A)	vard transconductance	5 V as a function of Fig 6. Output of function 003aae786 Poson (mΩ) 20 20 20 20 20 20 20 20	characteristics:	drain cu e voltage	e; typica	
60 (A)	vard transconductance an current; typical values	5 V as a function of $Fig 6.$ Output of function $003aae786$ $(m\Omega)$ $20$ $15$ $15$	characteristics:	drain cu e voltage	e; typica	
60	vard transconductance an current; typical values	5 V as a function of $Fig 6.$ Output of function $003aae786$ $R_{DSon}$ $(m\Omega)$ $20$ $15$ $10$ $10$ $10$	characteristics:	drain cu e voltage	e; typica	
60 (A) 40	vard transconductance an current; typical values	5 V as a function of $Fig 6.$ Output of function $003aae786$ $R_{DSon}$ $(m\Omega)$ $20$ $15$ $10$ $10$ $10$	characteristics:		e; typica	ıl valı
drain 60 I <sub>D</sub> (A) 40 20 0	ward transconductance an current; typical values $T_j = 175 \circ C$ $T_j = 1000$	5 V as a function of $Fig 6.$ Output of function $003aae786$ $(m\Omega)$ $20$ $15$ $10$ $15$ $10$ $5$ $0$ $0$ $25 \circ C$ $10$ $5$ $0$ $0$	characteristics: of drain-source	drain cu e voltage	e; typica	ıl valı

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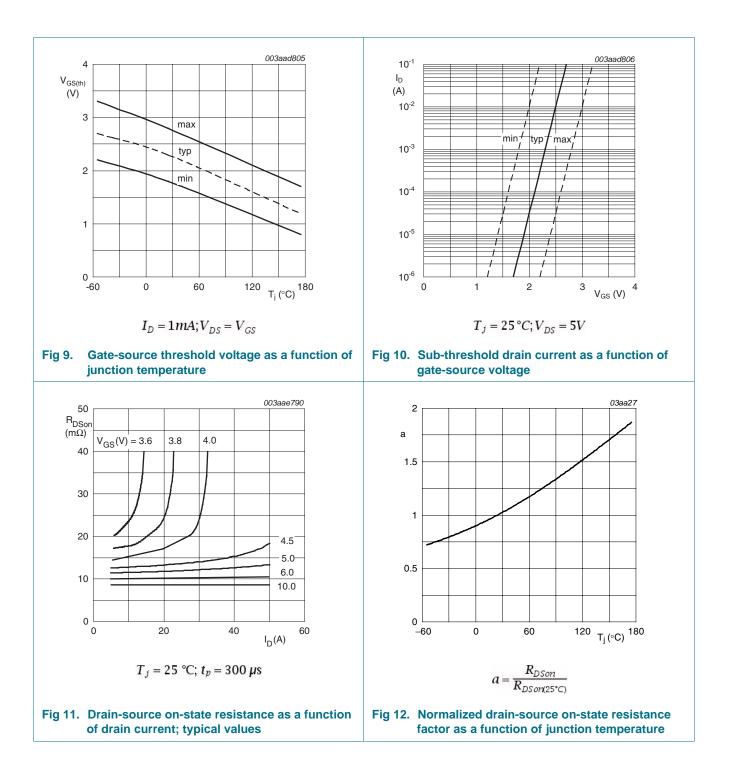
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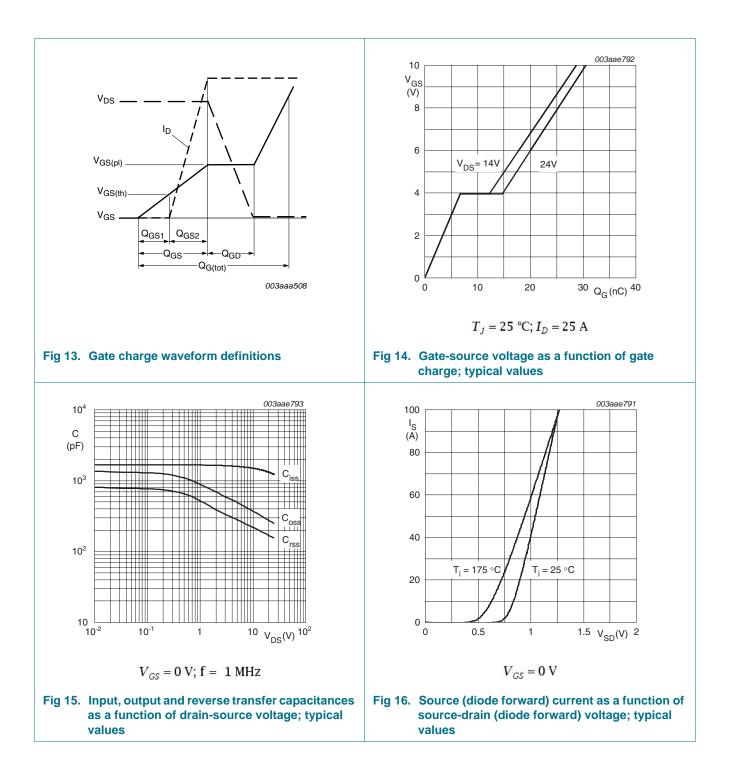


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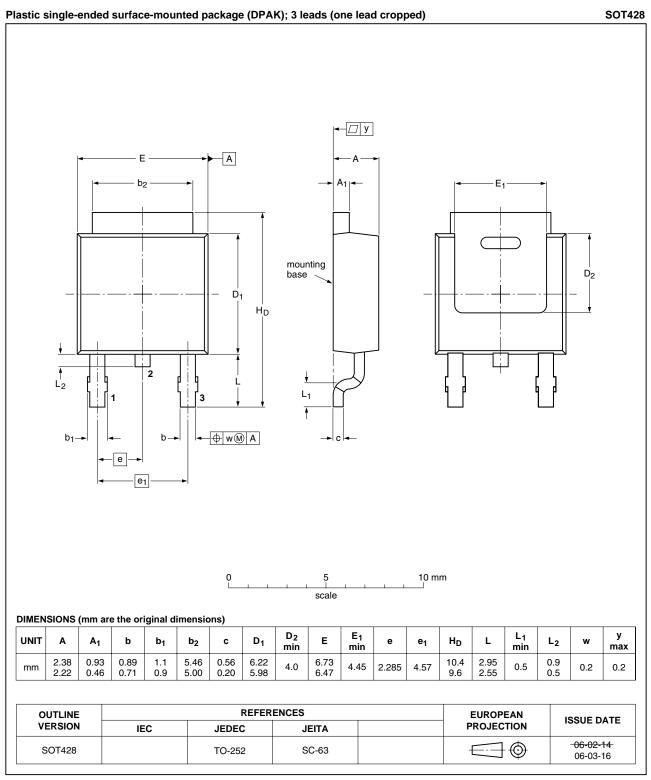


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Product data sheet

#### N-channel TrenchMOS intermediate level FET

### 7. Package outline



#### Fig 17. Package outline SOT428 (DPAK)

BUK6209-30C Product data sheet

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### 8. Revision history

Table 7.Revision history	
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Document ID	Release date	Data sheet status	Change notice	Supersedes
BUK6209-30C v.2	20101001	Product data sheet	-	BUK6209-30C v.1
Modifications:	<ul> <li>Status change</li> </ul>	ed from objective to product.		
BUK6209-30C v.1	20100908	Objective data sheet	-	-

#### N-channel TrenchMOS intermediate level FET

#### 9. Legal information

#### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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